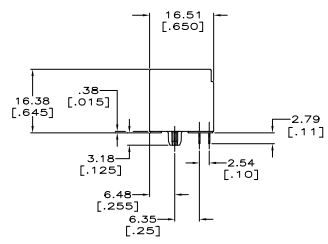
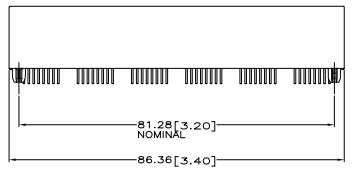
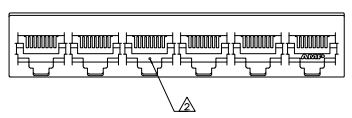
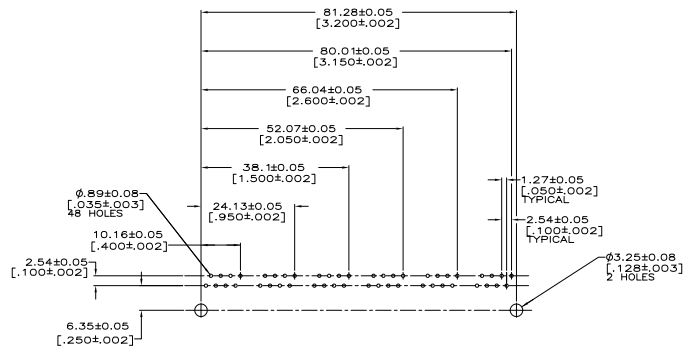


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REV	DATE	DESCRIPTION	BY	CHK
HM 00				
F		REV 02-06-2008	22MPS06	LH SH



- △ MATERIAL: HOUSING - POLYESTER MOLDING COMPOUND, BLACK, UL 94V-0.
 TERMINALS - 0.33 [0.13] THICK PHOS BRONZE PLATED WITH 1.27µm [0.00050] MINIMUM HARD GOLD IN LOCALIZED AREA AND 3.51µm [0.00150] MINIMUM MATTE-TIN IN SOLDER AREA OVER 1.27µm [0.00050] MINIMUM NICKEL UNDERPLATE.
 TERMINAL INSERT PLASTIC: POLYESTER MOLDING COMPOUND, GRAY, UL 94V-0.
- △ JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68, SUBPART F.
- △ CAUTION: CATEGORY 5 JACK SOLDER TAIL POSITIONS DO NOT FOLLOW SAME NUMBER SEQUENCE AS THAT OF THE TRADITIONAL JACKS.



SUGGESTED PC BOARD LAYOUT
 COMPONENT SIDE
 SEE APPLICATION SPECIFICATION

569748-1
 PART NO.

THIS DRAWING IS A CONTROLLED DOCUMENT.		REV	DATE	DESCRIPTION	BY	CHK
DESIGNER	DATE	REV	DATE	DESCRIPTION	BY	CHK
108-1163-2	114-2048	A1	00779	G=569748		
CUSTOMER DRAWING		SIZE	DATE	ISSUE	REV	BY
		A1	00779	G=569748	2-1	1 F